

PNP SILICON DUAL TRANSISTOR

Qualified per MIL-PRF-19500/336

Devices

2N3810	2N3811
2N3810L	2N3811L
2N3810U	2N3811U

Qualified Level

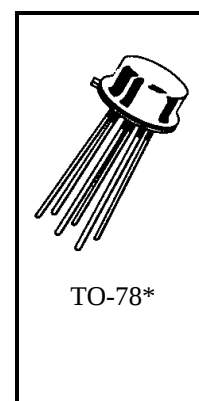
JAN
JANTX
JANTXV

MAXIMUM RATINGS

Ratings	Symbol	Value	Unit
Collector-Emitter Voltage	V_{CEO}	60	Vdc
Collector-Base Voltage	V_{CBO}	60	Vdc
Emitter-Base Voltage	V_{EBO}	5.0	Vdc
Collector Current	I_C	50	mAdc
		One Section ¹	Both Sections ²
Total Power Dissipation @ $T_A = +25^\circ\text{C}$	P_T	0.5	0.6
Operating & Storage Junction Temperature Range	T_J, T_{stg}	-65 to +200	$^\circ\text{C}$

1) Derate linearly 2.86 mW/ $^\circ\text{C}$ for $T_A > +25^\circ\text{C}$

2) Derate linearly 3.43 mW/ $^\circ\text{C}$ for $T_A > +25^\circ\text{C}$



TO-78*

*See appendix A for package outline

ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ unless otherwise noted)

Characteristics	Symbol	Min.	Max.	Unit
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OFF CHARACTERISTICS

Collector-Base Breakdown Voltage $I_C = 10 \mu\text{Adc}$	$V_{(BR)CBO}$	60		Vdc
Collector-Emitter Breakdown Current $I_C = 10 \text{ mAdc}$	$V_{(BR)CEO}$	60		Vdc
Emitter-Base Breakdown Voltage $I_E = 10 \mu\text{Adc}$	$V_{(BR)EBO}$	5.0		Vdc
Collector-Base Cutoff Current $V_{CB} = 50 \text{ Vdc}$	I_{CBO}		10	ηAdc
Emitter-Base Cutoff Current $V_{EB} = 4.0 \text{ Vdc}$	I_{EBO}		10	ηAdc

ELECTRICAL CHARACTERISTICS (con't)

Characteristics	Symbol	Min.	Max.	Unit
ON CHARACTERISTICS (3)				
Forward-Current Transfer Ratio I _C = 10 μAdc, V _{CE} = 5.0 Vdc I _C = 100 μAdc, V _{CE} = 5.0 Vdc I _C = 500 μAdc, V _{CE} = 5.0 Vdc I _C = 1.0 mAdc, V _{CE} = 5.0 Vdc I _C = 10 mAdc, V _{CE} = 5.0 Vdc I _C = 1.0 μAdc, V _{CE} = 5.0Vdc I _C = 10 μAdc, V _{CE} = 5.0 Vdc I _C = 100 μAdc, V _{CE} = 5.0 Vdc I _C = 500 μAdc, V _{CE} = 5.0 Vdc I _C = 1.0 mAdc, V _{CE} = 5.0 Vdc I _C = 10 mAdc, V _{CE} = 5.0 Vdc	2N3810, 2N3810L 2N3811, 2N3811L	 		

DYNAMIC CHARACTERISTICS

Forward Current Transfer Ratio, Magnitude $I_C = 500 \mu\text{Adc}, V_{CE} = 5.0 \text{ Vdc}, f = 30 \text{ MHz}$ $I_C = 1.0 \text{ mAdc}, V_{CE} = 5.0 \text{ Vdc}, f = 100 \text{ MHz}$	$ h_{fe} $	1.0 1.0	5.0	
Small-Signal Short Circuit Forward Current Transfer Ratio $I_C = 1.0 \text{ mAdc}, V_{CE} = 10 \text{ Vdc}, f = 1.0 \text{ kHz}$ 2N3810, L 2N3811, L	h_{fe}	150 300	600 900	
Small-Signal Short Circuit Input Impedance $I_C = 1.0 \text{ mAdc}, V_{CE} = 10 \text{ Vdc}, f = 1.0 \text{ kHz}$ 2N3810, L 2N3811, L	h_{ie}	3.0 3.0	30 40	k Ω
Small-Signal Short Circuit Output Admittance $I_C = 1.0 \text{ mAdc}, V_{CE} = 10 \text{ Vdc}, f = 1.0 \text{ kHz}$	h_{oe}	5.0	60	μmhos
Output Capacitance $V_{CB} = 5.0 \text{ Vdc}, I_E = 0, 100 \text{ kHz} \leq f \leq 1.0 \text{ MHz}$	C_{obo}		5.0	pF
Input Capacitance $V_{EB} = 0.5 \text{ Vdc}, I_C = 0, 100 \text{ kHz} \leq f \leq 1.0 \text{ MHz}$	C_{ibo}		8.0	pF
Noise Figure 2N3810, L $I_C = 100 \mu\text{Adc}, V_{CE} = 10 \text{ Vdc}, f = 100 \text{ Hz}, R_G = 3.0 \text{ k}\Omega$ $I_C = 100 \mu\text{Adc}, V_{CE} = 10 \text{ Vdc}, f = 1.0 \text{ kHz}, R_G = 3.0 \text{ k}\Omega$ $I_C = 100 \mu\text{Adc}, V_{CE} = 10 \text{ Vdc}, f = 10 \text{ kHz}, R_G = 3.0 \text{ k}\Omega$ $I_C = 100 \mu\text{Adc}, V_{CE} = 10 \text{ Vdc}, f = 10 \text{ Hz to } 15.7 \text{ kHz}, R_G = 3.0 \text{ k}\Omega$ 2N3811, L $I_C = 100 \mu\text{Adc}, V_{CE} = 10 \text{ Vdc}, f = 100 \text{ Hz}, R_G = 3.0 \text{ k}\Omega$ $I_C = 100 \mu\text{Adc}, V_{CE} = 10 \text{ Vdc}, f = 1.0 \text{ kHz}, R_G = 3.0 \text{ k}\Omega$ $I_C = 100 \mu\text{Adc}, V_{CE} = 10 \text{ Vdc}, f = 10 \text{ kHz}, R_G = 3.0 \text{ k}\Omega$ $I_C = 100 \mu\text{Adc}, V_{CE} = 10 \text{ Vdc}, f = 10 \text{ Hz to } 15.7 \text{ kHz}, R_G = 3.0 \text{ k}\Omega$	F_1 F_2 F_3 F_4 F_1 F_2 F_3 F_4		7.0 3.0 2.5 3.5 4.0 1.5 2.0 2.5	dB dB

(3) Pulse Test: Pulse Width = 300 μs , Duty Cycle $\leq 2.0\%$.